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#### Understanding Embedded - Microprocessors

Embedded microprocessors are specialized computing chips designed to perform specific tasks within an embedded system. Unlike general-purpose microprocessors found in personal computers, embedded microprocessors are tailored for dedicated functions within larger systems, offering optimized performance, efficiency, and reliability. These microprocessors are integral to the operation of countless electronic devices, providing the computational power necessary for controlling processes, handling data, and managing communications.

#### Applications of **Embedded - Microprocessors**

Embedded microprocessors are utilized across a broad spectrum of applications, making them indispensable in

#### Details

Product Status	Obsolete
Core Processor	MPC8xx
Number of Cores/Bus Width	1 Core, 32-Bit
Speed	50MHz
Co-Processors/DSP	Communications; CPM
RAM Controllers	DRAM
Graphics Acceleration	No
Display & Interface Controllers	-
Ethernet	10Mbps (4), 10/100Mbps (1)
SATA	-
USB	-
Voltage - I/O	3.3V
Operating Temperature	0°C ~ 95°C (TA)
Security Features	-
Package / Case	357-BBGA
Supplier Device Package	357-PBGA (25x25)
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/mpc860tzq50d4

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong



Overview

# 1 Overview

The MPC860 power quad integrated communications controller (PowerQUICC<sup>TM</sup>) is a versatile one-chip integrated microprocessor and peripheral combination designed for a variety of controller applications. It particularly excels in communications and networking systems. The PowerQUICC unit is referred to as the MPC860 in this hardware specification.

The MPC860 implements Power Architecture<sup>TM</sup> technology and contains a superset of Freescale's MC68360 quad integrated communications controller (QUICC), referred to here as the QUICC, RISC communications proceessor module (CPM). The CPU on the MPC860 is a 32-bit core built on Power Architecture technology that incorporates memory management units (MMUs) and instruction and data caches.. The CPM from the MC68360 QUICC has been enhanced by the addition of the inter-integrated controller (I<sup>2</sup>C) channel. The memory controller has been enhanced, enabling the MPC860 to support any type of memory, including high-performance memories and new types of DRAMs. A PCMCIA socket controller supports up to two sockets. A real-time clock has also been integrated.

Table 1 shows the functionality supported by the MPC860 family.

Part	Cache (	Cache (Kbytes)		Ethernet			
	Instruction Cache	Data Cache	10T	10/100	АТМ	SCC	Reference <sup>1</sup>
MPC860DE	4	4	Up to 2	_	_	2	1
MPC860DT	4	4	Up to 2	1	Yes	2	1
MPC860DP	16	8	Up to 2	1	Yes	2	1
MPC860EN	4	4	Up to 4	_	_	4	1
MPC860SR	4	4	Up to 4	—	Yes	4	1
MPC860T	4	4	Up to 4	1	Yes	4	1
MPC860P	16	8	Up to 4	1	Yes	4	1
MPC855T	4	4	1	1	Yes	1	2

Table 1. MPC860 Family Functionality

Supporting documentation for these devices refers to the following:

1. MPC860 PowerQUICC Family User's Manual (MPC860UM, Rev. 3)

2. MPC855T User's Manual (MPC855TUM, Rev. 1)



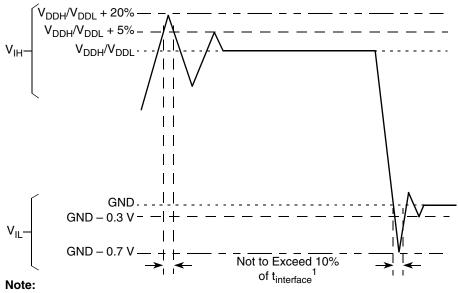
Features

- System integration unit (SIU)
  - Bus monitor
  - Software watchdog
  - Periodic interrupt timer (PIT)
  - Low-power stop mode
  - Clock synthesizer
  - Decrementer, time base, and real-time clock (RTC)
  - Reset controller
  - IEEE 1149.1<sup>TM</sup> Std. test access port (JTAG)
- Interrupts
  - Seven external interrupt request (IRQ) lines
  - 12 port pins with interrupt capability
  - 23 internal interrupt sources
  - Programmable priority between SCCs
  - Programmable highest priority request
- 10/100 Mbps Ethernet support, fully compliant with the IEEE 802.3u® Standard (not available when using ATM over UTOPIA interface)
- ATM support compliant with ATM forum UNI 4.0 specification
  - Cell processing up to 50–70 Mbps at 50-MHz system clock
  - Cell multiplexing/demultiplexing
  - Support of AAL5 and AAL0 protocols on a per-VC basis. AAL0 support enables OAM and software implementation of other protocols.
  - ATM pace control (APC) scheduler, providing direct support for constant bit rate (CBR) and unspecified bit rate (UBR) and providing control mechanisms enabling software support of available bit rate (ABR)
  - Physical interface support for UTOPIA (10/100-Mbps is not supported with this interface) and byte-aligned serial (for example, T1/E1/ADSL)
  - UTOPIA-mode ATM supports level-1 master with cell-level handshake, multi-PHY (up to four physical layer devices), connection to 25-, 51-, or 155-Mbps framers, and UTOPIA/system clock ratios of 1/2 or 1/3.
  - Serial-mode ATM connection supports transmission convergence (TC) function for T1/E1/ADSL lines, cell delineation, cell payload scrambling/descrambling, automatic idle/unassigned cell insertion/stripping, header error control (HEC) generation, checking, and statistics.
- Communications processor module (CPM)
  - RISC communications processor (CP)
  - Communication-specific commands (for example, GRACEFUL STOP TRANSMIT, ENTER HUNT MODE, and RESTART TRANSMIT)
  - Supports continuous mode transmission and reception on all serial channels



#### Thermal Characteristics

Figure 1 shows the undershoot and overshoot voltages at the interface of the MPC860.



1. t<sub>interface</sub> refers to the clock period associated with the bus clock interface.

Figure 1. Undershoot/Overshoot Voltage for V<sub>DDH</sub> and V<sub>DDL</sub>

## 4 Thermal Characteristics

#### Table 3. Package Description

Package Designator	Package Code (Case No.)	Package Description
ZP	5050 (1103-01)	PBGA 357 25*25*0.9P1.27
ZQ/VR	5058 (1103D-02)	PBGA 357 25*25*1.2P1.27



**Power Dissipation** 

# 5 **Power Dissipation**

Table 5 provides power dissipation information. The modes are 1:1, where CPU and bus speeds are equal, and 2:1, where CPU frequency is twice the bus speed.

Die Revision	Frequency (MHz)	Typical <sup>1</sup>	Maximum <sup>2</sup>	Unit
D.4	50	656	735	mW
:1 mode)	66	TBD	TBD	mW
D.4	66	722	762	mW
(2:1 mode)	80	851	909	mW

### Table 5. Power Dissipation (PD)

<sup>1</sup> Typical power dissipation is measured at 3.3 V.

<sup>2</sup> Maximum power dissipation is measured at 3.5 V.

NOTE

Values in Table 5 represent  $V_{DDL}$ -based power dissipation and do not include I/O power dissipation over  $V_{DDH}$ . I/O power dissipation varies widely by application due to buffer current, depending on external circuitry.

# 6 DC Characteristics

Table 6 provides the DC electrical characteristics for the MPC860.

 Table 6. DC Electrical Specifications

Characteristic	Symbol	Min	Мах	Unit
Operating voltage at 40 MHz or less	V <sub>DDH</sub> , V <sub>DDL</sub> , V <sub>DDSYN</sub>	3.0	3.6	V
	KAPWR (power-down mode)	2.0	3.6	V
	KAPWR (all other operating modes)	V <sub>DDH</sub> – 0.4	V <sub>DDH</sub>	V
Operating voltage greater than 40 MHz	V <sub>DDH</sub> , V <sub>DDL</sub> , KAPWR, V <sub>DDSYN</sub>	3.135	3.465	V
	KAPWR (power-down mode)	2.0	3.6	V
	KAPWR (all other operating modes)	V <sub>DDH</sub> – 0.4	V <sub>DDH</sub>	V
Input high voltage (all inputs except EXTAL and EXTCLK)	V <sub>IH</sub>	2.0	5.5	V
Input low voltage <sup>1</sup>	V <sub>IL</sub>	GND	0.8	V
EXTAL, EXTCLK input high voltage	V <sub>IHC</sub>	$0.7  imes (V_{DDH})$	V <sub>DDH</sub> + 0.3	V
Input leakage current, $V_{in} = 5.5 \text{ V}$ (except TMS, TRST, DSCK, and DSDI pins)	l <sub>in</sub>	_	100	μA



NI	Ohannasharilatia	33	MHz	40 1	MHz	50 I	MHz	66 I	MHz	11
Num	Characteristic	Min	Мах	Min	Мах	Min	Max	Min	Мах	Unit
B35	A(0:31), BADDR(28:30) to CS valid—as requested by control bit BST4 in the corresponding word in UPM	5.58		4.25		3.00	_	1.79		ns
B35a	A(0:31), BADDR(28:30), and D(0:31) to $\overline{\text{BS}}$ valid—as requested by control bit BST1 in the corresponding word in UPM	13.15		10.50	—	8.00	_	5.58		ns
B35b	A(0:31), BADDR(28:30), and D(0:31) to $\overline{\text{BS}}$ valid—as requested by control bit BST2 in the corresponding word in UPM	20.73		16.75	—	13.00	_	9.36		ns
B36	A(0:31), BADDR(28:30), and D(0:31) to GPL valid—as requested by control bit GxT4 in the corresponding word in UPM	5.58		4.25		3.00	_	1.79		ns
B37	UPWAIT valid to CLKOUT falling edge9	6.00		6.00		6.00	_	6.00		ns
B38	CLKOUT falling edge to UPWAIT valid <sup>9</sup>	1.00	_	1.00	_	1.00		1.00		ns
B39	AS valid to CLKOUT rising edge <sup>10</sup>	7.00		7.00		7.00	_	7.00		ns
B40	A(0:31), TSIZ(0:1), RD/WR, BURST, valid to CLKOUT rising edge	7.00		7.00	_	7.00		7.00	—	ns
B41	$\overline{\text{TS}}$ valid to CLKOUT rising edge (setup time)	7.00		7.00		7.00	_	7.00		ns
B42	CLKOUT rising edge to $\overline{TS}$ valid (hold time)	2.00	_	2.00	_	2.00	_	2.00	_	ns
B43	AS negation to memory controller signals negation	_	TBD	_	TBD	—	TBD	_	TBD	ns

Table 7	Bus O	neration	Timinas	(continued)
	Du3 0	peration	rinnigs	(continucu)

<sup>1</sup> Phase and frequency jitter performance results are only valid if the input jitter is less than the prescribed value.

<sup>2</sup> If the rate of change of the frequency of EXTAL is slow (that is, it does not jump between the minimum and maximum values in one cycle) or the frequency of the jitter is fast (that is, it does not stay at an extreme value for a long time) then the maximum allowed jitter on EXTAL can be up to 2%.

<sup>3</sup> The timings specified in B4 and B5 are based on full strength clock.

<sup>4</sup> The timing for BR output is relevant when the MPC860 is selected to work with external bus arbiter. The timing for BG output is relevant when the MPC860 is selected to work with internal bus arbiter.

<sup>5</sup> The timing required for BR input is relevant when the MPC860 is selected to work with internal bus arbiter. The timing for BG input is relevant when the MPC860 is selected to work with external bus arbiter.

<sup>6</sup> The D(0:31) and DP(0:3) input timings B18 and B19 refer to the rising edge of the CLKOUT in which the TA input signal is asserted.

<sup>7</sup> The D(0:31) and DP(0:3) input timings B20 and B21 refer to the falling edge of the CLKOUT. This timing is valid only for read accesses controlled by chip-selects under control of the UPM in the memory controller, for data beats where DLT3 = 1 in the UPM RAM words. (This is only the case where data is latched on the falling edge of CLKOUT.)

<sup>8</sup> The timing B30 refers to  $\overline{CS}$  when ACS = 00 and to  $\overline{WE}(0:3)$  when CSNT = 0.

<sup>9</sup> The signal UPWAIT is considered asynchronous to the CLKOUT and synchronized internally. The timings specified in B37 and B38 are specified to enable the freeze of the UPM output signals as described in Figure 18.

<sup>10</sup> The AS signal is considered asynchronous to the CLKOUT. The timing B39 is specified in order to allow the behavior specified in Figure 21.



Figure 3 is the control timing diagram.

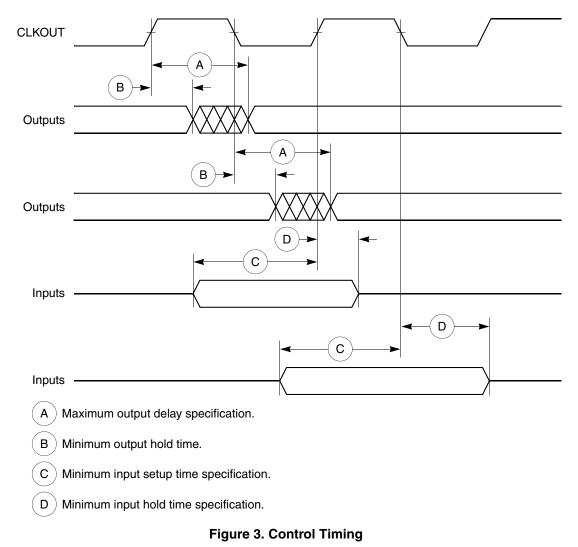


Figure 4 provides the timing for the external clock.

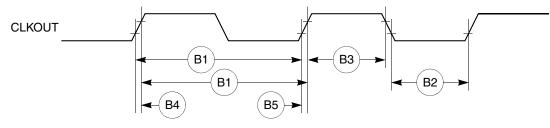


Figure 4. External Clock Timing

#### MPC860 PowerQUICC Family Hardware Specifications, Rev. 10



Figure 5 provides the timing for the synchronous output signals.

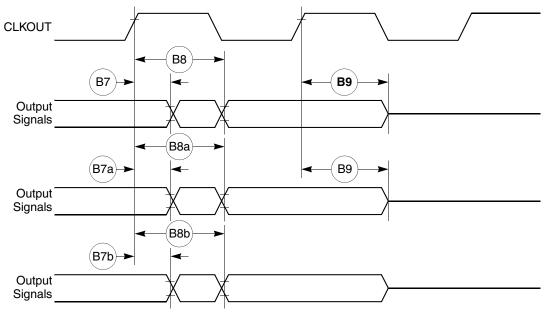


Figure 5. Synchronous Output Signals Timing

Figure 6 provides the timing for the synchronous active pull-up and open-drain output signals.

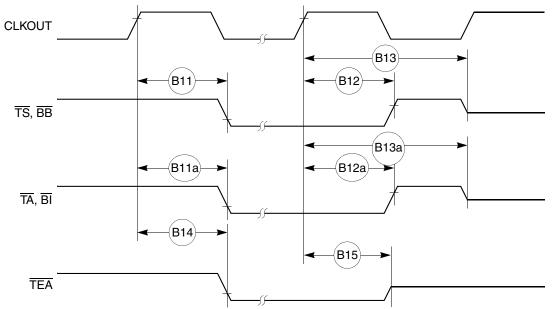
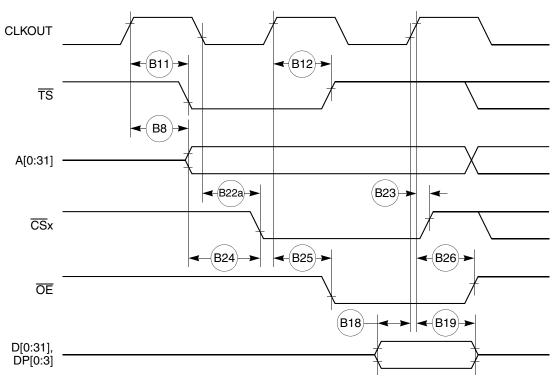


Figure 6. Synchronous Active Pull-Up Resistor and Open-Drain Outputs Signals Timing







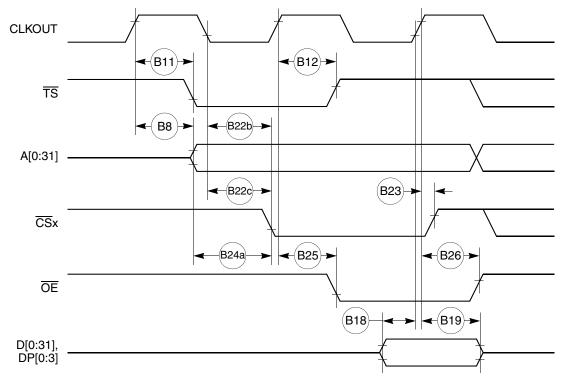


Figure 12. External Bus Read Timing (GPCM Controlled—TRLX = 0, ACS = 11)

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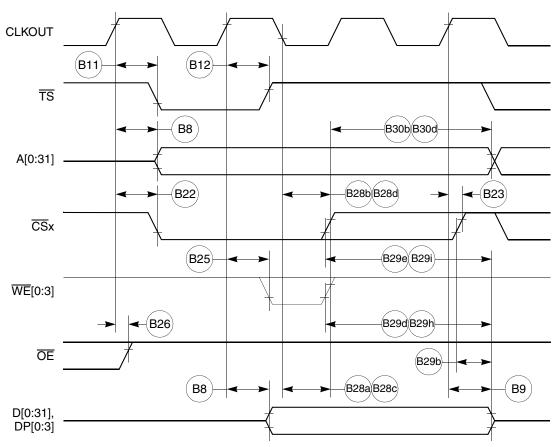


Figure 16. External Bus Write Timing (GPCM Controlled—TRLX = 0 or 1, CSNT = 1)



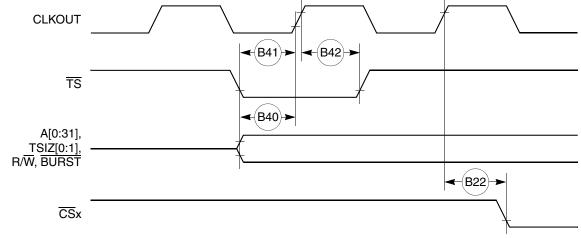


Figure 20 provides the timing for the synchronous external master access controlled by the GPCM.

Figure 20. Synchronous External Master Access Timing (GPCM Handled ACS = 00)

Figure 21 provides the timing for the asynchronous external master memory access controlled by the GPCM.

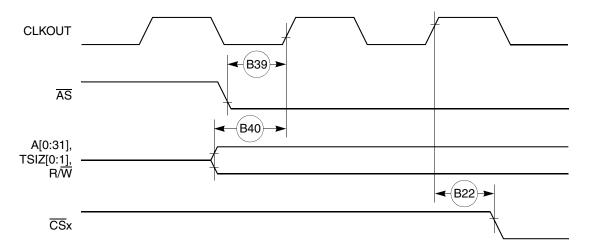




Figure 22 provides the timing for the asynchronous external master control signals negation.

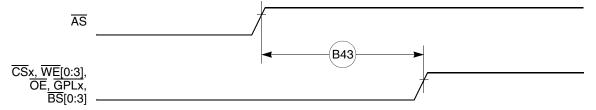


Figure 22. Asynchronous External Master—Control Signals Negation Timing



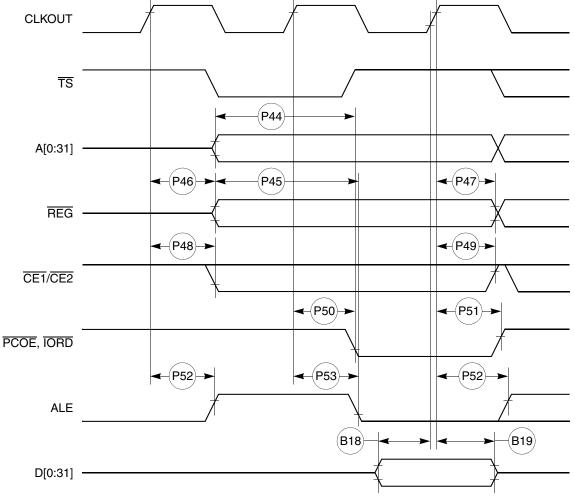
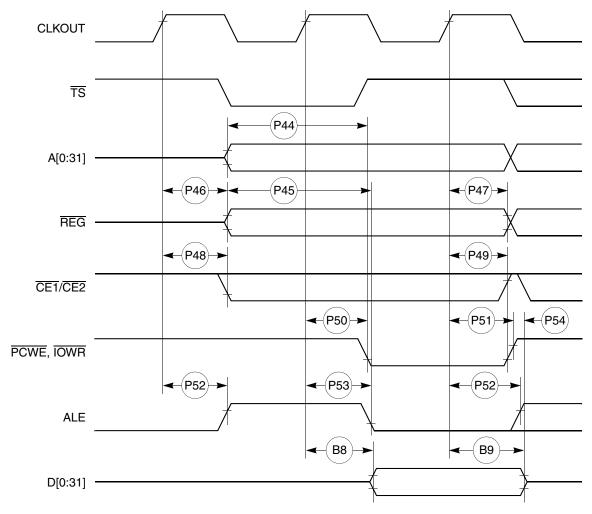


Figure 25 provides the PCMCIA access cycle timing for the external bus read.

Figure 25. PCMCIA Access Cycle Timing External Bus Read







### Figure 26. PCMCIA Access Cycle Timing External Bus Write

Figure 27 provides the PCMCIA  $\overline{WAIT}$  signal detection timing.

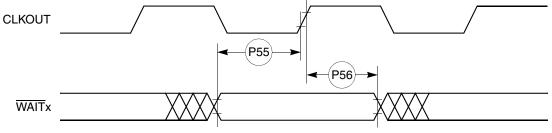


Figure 27. PCMCIA WAIT Signal Detection Timing

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Num	Characteristic	All Freq	uencies	Unit
	Characteristic	Min	Мах	Unit
42	SDACK assertion delay from clock high	—	12	ns
43	SDACK negation delay from clock low	—	12	ns
44	SDACK negation delay from TA low	—	20	ns
45	SDACK negation delay from clock high	—	15	ns
46	$\overline{TA}$ assertion to rising edge of the clock setup time (applies to external $\overline{TA}$ )	7		ns

### Table 16. IDMA Controller Timing (continued)

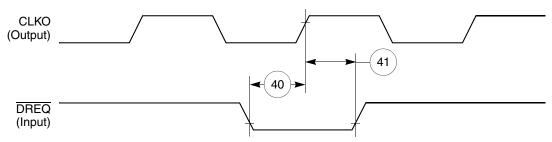


Figure 45. IDMA External Requests Timing Diagram

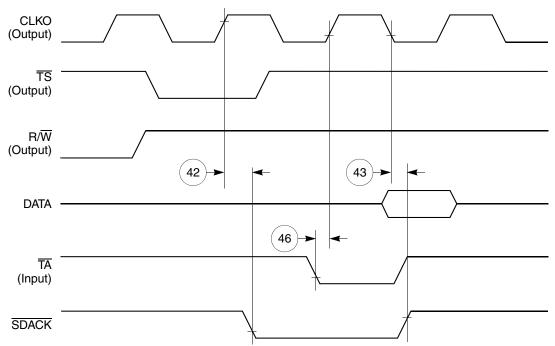


Figure 46. SDACK Timing Diagram—Peripheral Write, Externally-Generated TA



Num	Characteristic	All Freq	uencies	Unit
	Characteristic	Min	Max	Unit
84	L1CLK edge to L1CLKO valid (DSC = 1)	_	30.00	ns
85	L1RQ valid before falling edge of L1TSYNC <sup>4</sup>	1.00	—	L1TCL K
86	L1GR setup time <sup>2</sup>	42.00	_	ns
87	L1GR hold time	42.00	—	ns
88	L1CLK edge to L1SYNC valid (FSD = 00) CNT = 0000, BYT = 0, DSC = 0)	_	0.00	ns

### Table 19. SI Timing (continued)

<sup>1</sup> The ratio SYNCCLK/L1RCLK must be greater than 2.5/1.

<sup>2</sup> These specs are valid for IDL mode only.

<sup>3</sup> Where P = 1/CLKOUT. Thus, for a 25-MHz CLKO1 rate, P = 40 ns.

<sup>4</sup> These strobes and TxD on the first bit of the frame become valid after L1CLK edge or L1SYNC, whichever comes later.

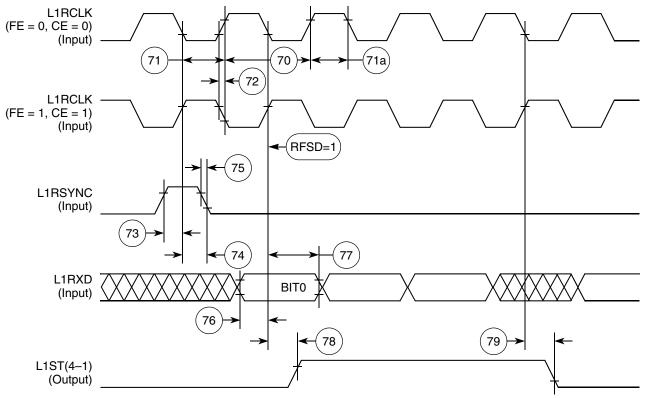
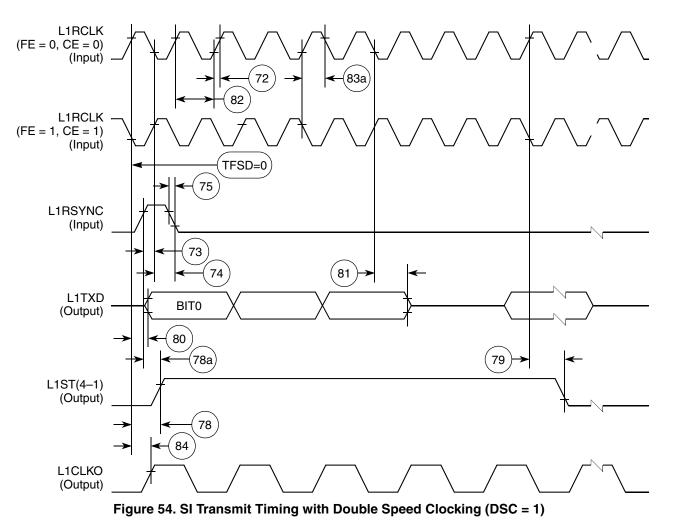


Figure 51. SI Receive Timing Diagram with Normal Clocking (DSC = 0)



**CPM Electrical Characteristics** 



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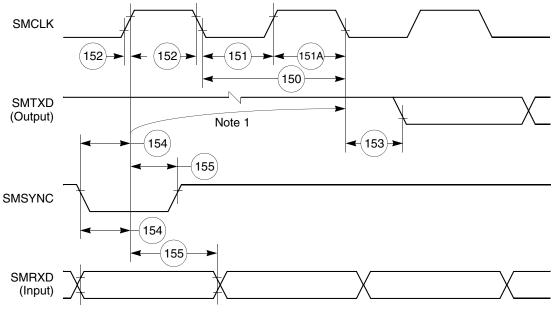
#### **SMC Transparent AC Electrical Specifications** 11.9

Table 23 provides the SMC transparent timings as shown in Figure 64.

### Table 23. SMC Transparent Timing

Num	Characteristic	All Freque	uencies	Unit
Num	Characteristic	Min	Мах	Unit
150	SMCLK clock period <sup>1</sup>	100	—	ns
151	SMCLK width low	50	—	ns
151A	SMCLK width high	50	—	ns
152	SMCLK rise/fall time	_	15	ns
153	SMTXD active delay (from SMCLK falling edge)	10	50	ns
154	SMRXD/SMSYNC setup time	20	—	ns
155	RXD1/SMSYNC hold time	5	—	ns

<sup>1</sup> SYNCCLK must be at least twice as fast as SMCLK.



Note: 1. This delay is equal to an integer number of character-length clocks.



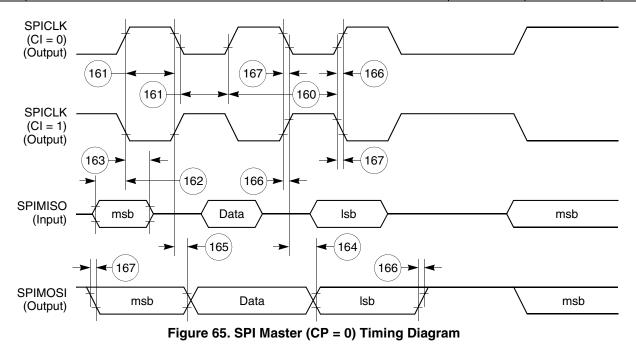


## **11.10 SPI Master AC Electrical Specifications**

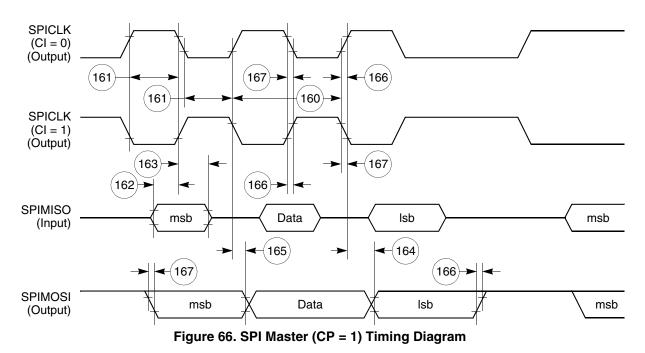
Table 24 provides the SPI master timings as shown in Figure 65 and Figure 66.

#### Table 24. SPI Master Timing

Num	Characteristic	All Frequ	uencies	Unit
num	Characteristic	Min	Мах	Unit
160	MASTER cycle time	4	1024	t <sub>cyc</sub>
161	MASTER clock (SCK) high or low time	2	512	t <sub>cyc</sub>
162	MASTER data setup time (inputs)	50	—	ns
163	Master data hold time (inputs)	0	—	ns
164	Master data valid (after SCK edge)	—	20	ns
165	Master data hold time (outputs)	0	—	ns
166	Rise time output	—	15	ns
167	Fall time output	—	15	ns







## **11.11 SPI Slave AC Electrical Specifications**

Table 25 provides the SPI slave timings as shown in Figure 67 and Figure 68.

## Table 25. SPI Slave Timing

Num	Characteristic	All Freq	uencies	Unit
Num	Unaracteristic	Min	Мах	Omi
170	Slave cycle time	2	—	t <sub>cyc</sub>
171	Slave enable lead time	15	—	ns
172	Slave enable lag time	15	—	ns
173	Slave clock (SPICLK) high or low time	1	—	t <sub>cyc</sub>
174	Slave sequential transfer delay (does not require deselect)	1	—	t <sub>cyc</sub>
175	Slave data setup time (inputs)	20	—	ns
176	Slave data hold time (inputs)	20	—	ns
177	Slave access time	_	50	ns



Figure 69 shows the  $I^2C$  bus timing.

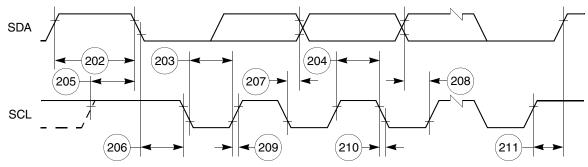


Figure 69. I<sup>2</sup>C Bus Timing Diagram

## **12 UTOPIA AC Electrical Specifications**

Table 28 shows the AC electrical specifications for the UTOPIA interface.

Num	Signal Characteristic	Direction	Min	Max	Unit
U1	UtpClk rise/fall time (Internal clock option)	Output	_	3.5	ns
	Duty cycle		50	50	%
	Frequency		—	50	MHz
U1a	UtpClk rise/fall time (external clock option)	Input	_	3.5	ns
	Duty cycle		40	60	%
	Frequency		_	50	MHz
U2	RxEnb and TxEnb active delay	Output	2	16	ns
U3	UTPB, SOC, Rxclav and Txclav setup time	Input	8	—	ns
U4	UTPB, SOC, Rxclav and Txclav hold time	Input	1	—	ns
U5	UTPB, SOC active delay (and PHREQ and PHSEL active delay in MPHY mode)	Output	2	16	ns

### Table 28. UTOPIA AC Electrical Specifications



Document Revision History

# **15 Document Revision History**

Table 35 lists significant changes between revisions of this hardware specification.

Revision	Date	Changes			
10 09/2015		In Table 34, moved MPC855TCVR50D4 and MPC855TCVR66D4 under the extended temperature (-40° to 95°C) and removed MC860ENCVR50D4R2 from the normal temperature Tape and Reel.			
9	10/2011	Updated orderable part numbers in Table 34, "MPC860 Family Package/Frequency Availability."			
8	08/2007	<ul> <li>Updated template.</li> <li>On page 1, added a second paragraph.</li> <li>After Table 2, inserted a new figure showing the undershoot/overshoot voltage (Figure 1) and renumbered the rest of the figures.</li> <li>In Figure 3, changed all reference voltage measurement points from 0.2 and 0.8 V to 50% level.</li> <li>In Table 16, changed num 46 description to read, "TA assertion to rising edge"</li> <li>In Figure 46, changed TA to reflect the rising edge of the clock.</li> </ul>			
7.0	9/2004	<ul> <li>Added a tablefootnote to Table 6 DC Electrical Specifications about meeting the VIL Max of the I2C Standard</li> <li>Replaced the thermal characteristics in Table 4 by the ZQ package</li> <li>Add the new parts to the Ordering and Availability Chart in Table 34</li> <li>Added the mechanical spec of the ZQ package in Figure 78</li> <li>Removed all of the old revisions from Table 5</li> </ul>			
6.3	9/2003	<ul><li>Added Section 11.2 on the Port C interrupt pins</li><li>Nontechnical reformatting</li></ul>			
6.2	8/2003	<ul> <li>Changed B28a through B28d and B29d to show that TRLX can be 0 or 1</li> <li>Changed reference documentation to reflect the Rev 2 MPC860 PowerQUICC Family Users Manual</li> <li>Nontechnical reformatting</li> </ul>			
6.1	11/2002	<ul> <li>Corrected UTOPIA RXenb* and TXenb* timing values</li> <li>Changed incorrect usage of Vcc to Vdd</li> <li>Corrected dual port RAM to 8 Kbytes</li> </ul>			
6	10/2002	Added the MPC855T. Corrected Figure 26 on page -36.			
5.1	11/2001	Revised template format, removed references to MAC functionality, changed Table 7 B23 max value @ 66 MHz from 2ns to 8ns, added this revision history table			

## Table 35. Document Revision History